

**ABSTRACT OF THE DISCLOSURE**

The present invention relates to a surface acoustic wave filter in which a plurality of pairs of comb electrode patterns are formed on an upper surface of a chip substrate made of a piezoelectric material. The surface acoustic wave filter includes a high-resistance pattern formed to surround a peripheral portion of the chip substrate on an upper surface side thereof, and a plurality of patterns formed to connect the high-resistance pattern to the respective comb electrode patterns.

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